



J012-8P8C-S-TH

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/SHIELDED) SIDE ENTRY

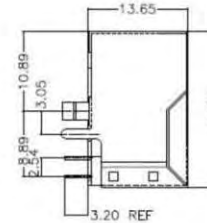
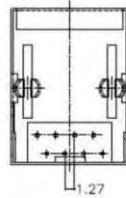
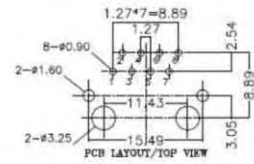
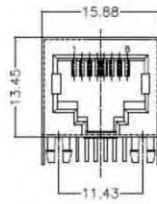
MATERIALS :

**HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."**

**PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."**

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.



J012-8P8C-TH

SPECIFICATIONS:

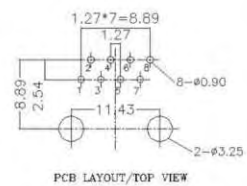
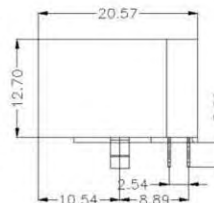
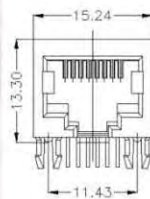
RJ45 8P8C PCB JACK TH (W/O SHIELDED) SIDE ENTRY

MATERIALS :

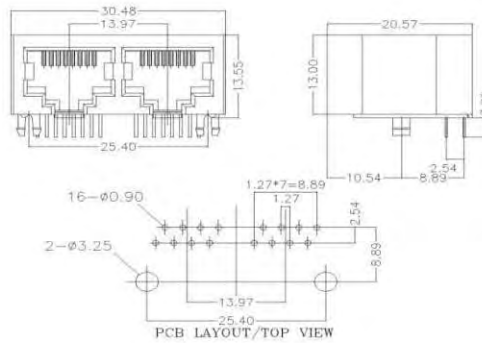
**HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."**

**PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."**

CONTACT: PHOSPHOR BRONZE.



J012 SERIES



JO12-8P8C-TH-2PORTS

SPECIFICATIONS:

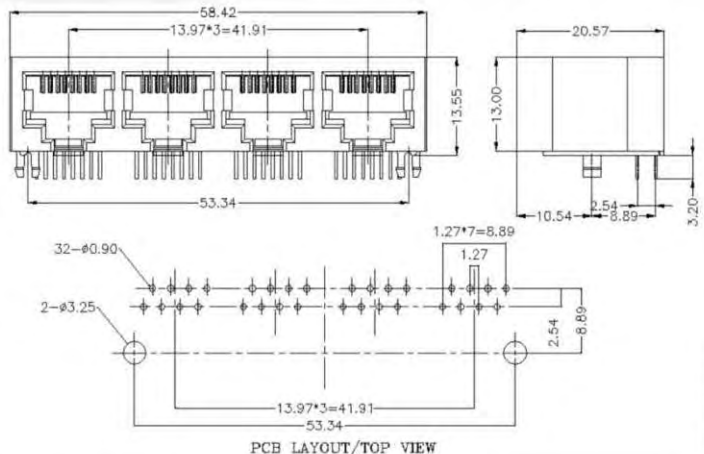
RJ45 8P8C PCB JACK TH (W/O SHIELDED) SIDE ENTRY

MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.



JO12-8P8C-TH-4PORTS

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/O SHIELDED) SIDE ENTRY

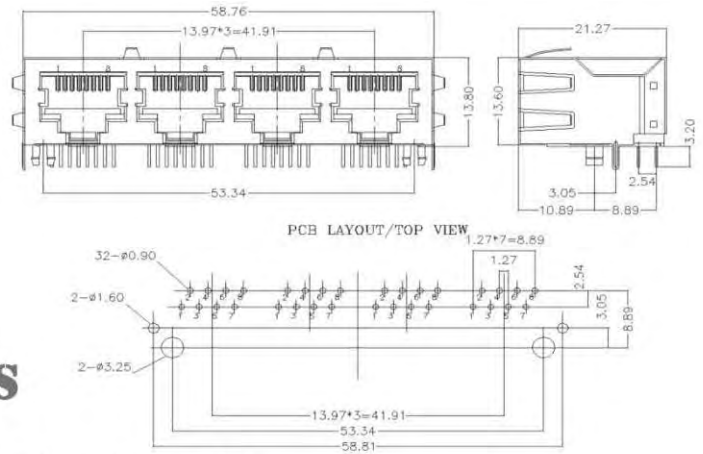
MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

JO12 SERIES



J012-8P8C-S-TH-4PORTS

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/SHIELDED) SIDE ENTRY

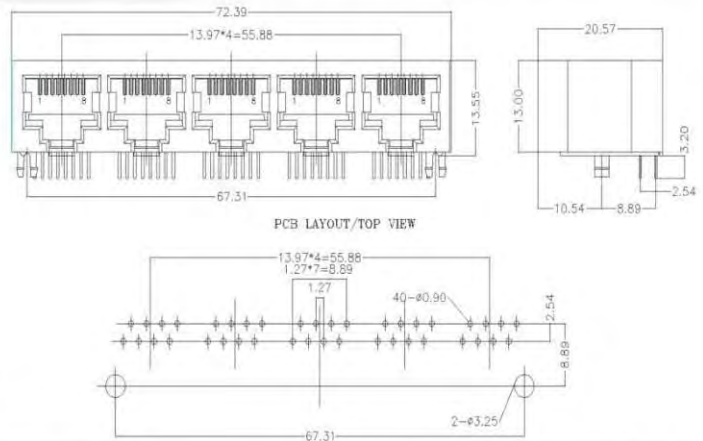
MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.



J012-8P8C-S-TH-5PORTS

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/O SHIELDED) SIDE ENTRY

MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

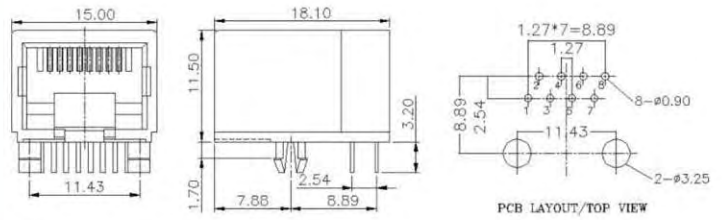
PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.

New Specification

J012 SERIES



J014-8P8C-TH

SPECIFICATIONS:

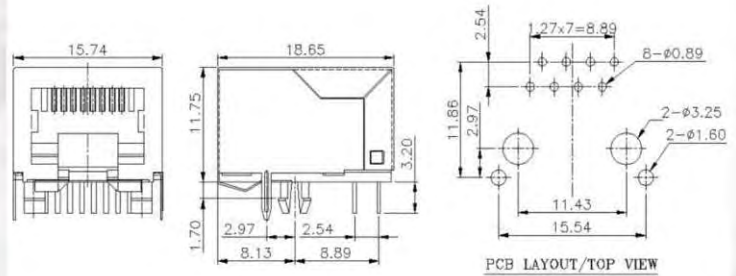
RJ45 8P8C PCB JACK TH (W/O SHIELDED) SIDE ENTRY

MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.



J014-8P8C-S-TH

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/SHIELDED) SIDE ENTRY

MATERIALS :

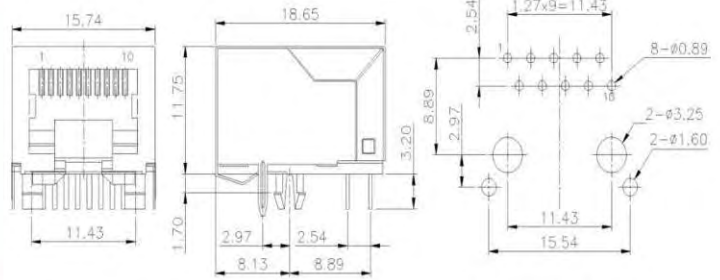
HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.

J014 SERIES



PCB LAYOUT/TOP VIEW

J014-10P10C-S-TH

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/SHIELDED OR W/O SHIELDED) SIDE ENTRY

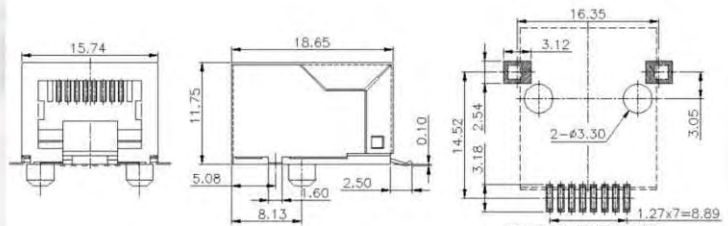
MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.



PCB LAYOUT/TOP VIEW

J014-8P8C-S-SMT

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/SHIELDED OR W/O SHIELDED) SIDE ENTRY

MATERIALS :

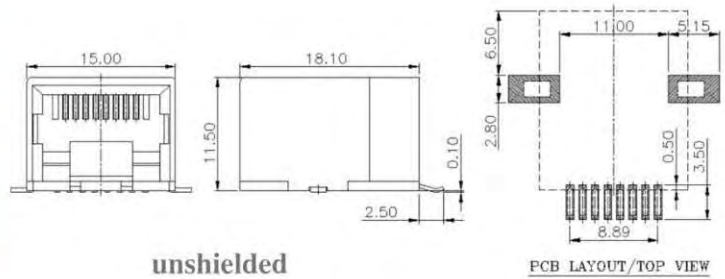
HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.

J014 SERIES



unshielded

PCB LAYOUT/TOP VIEW

J014-8P8C-S-SMT(2)

SPECIFICATIONS:

RJ45 8P8C PCB JACK SMT(W/SHIELDED OR W/O SHIELDED) SIDE ENTRY

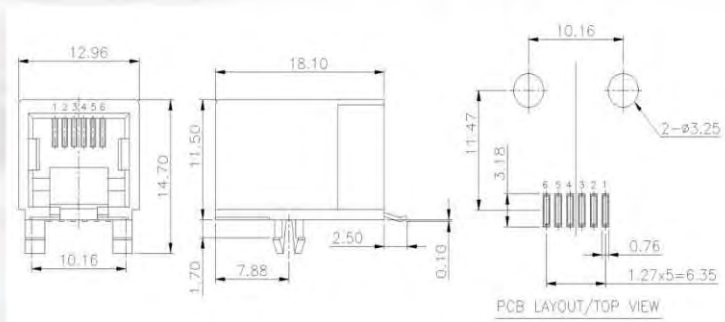
MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.



PCB LAYOUT/TOP VIEW

J014-6P6C-SMT

SPECIFICATIONS:

RJ12 6P6C PCB JACK SMT (W/O SHIELDED) SIDE ENTRY

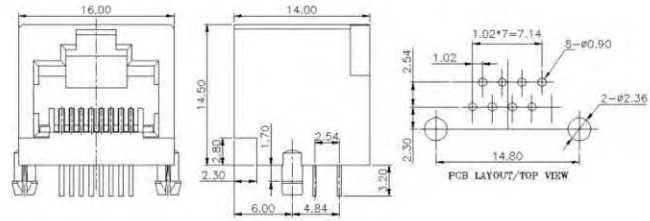
MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

J014 SERIES



J020-8P8C-TH

SPECIFICATIONS:

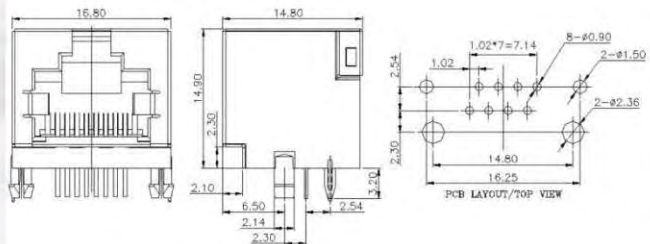
RJ45 8P8C PCB JACK TH (W/O SHIELDED) SIDE ENTRY

MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.



J020-8P8C-S-TH

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/SHIELDED) SIDE ENTRY

MATERIALS :

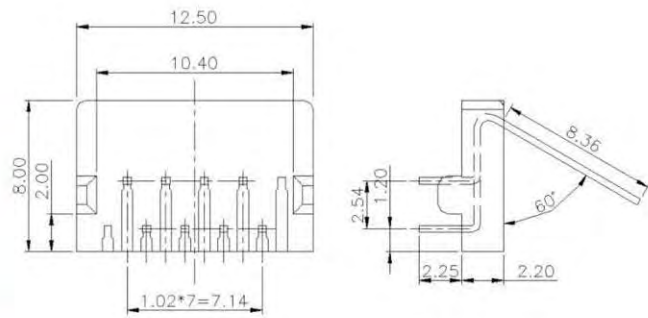
HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.

J020 SERIES



AJ020-8P8C

SPECIFICATIONS:

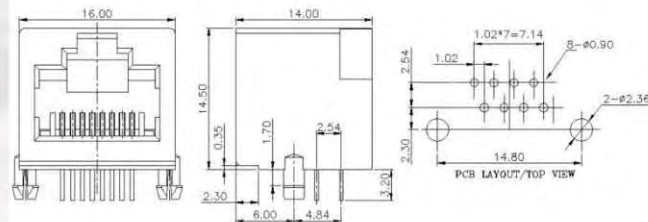
RJ45 8P8C PCB JACK TH

MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.



J021-8P8C-S-TH

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/SHIELDED OR W/O SHIELDED) SIDE ENTRY

MATERIALS :

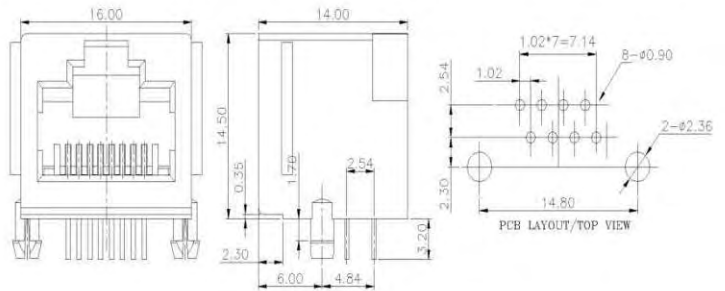
HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.

AJ020 SERIES J021 SERIES



J021-8P8C-TH-TYPE2

SPECIFICATIONS:

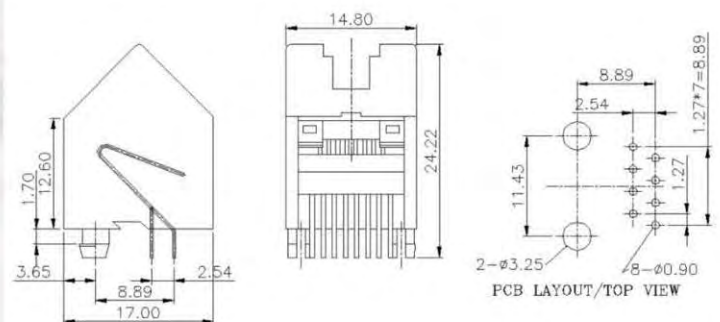
RJ12 6P6C PCB JACK TH (W/O SHIELDED) SIDE ENTRY

MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.



J045-8P8C-TH

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/O SHIELDED) 45 DEGREE

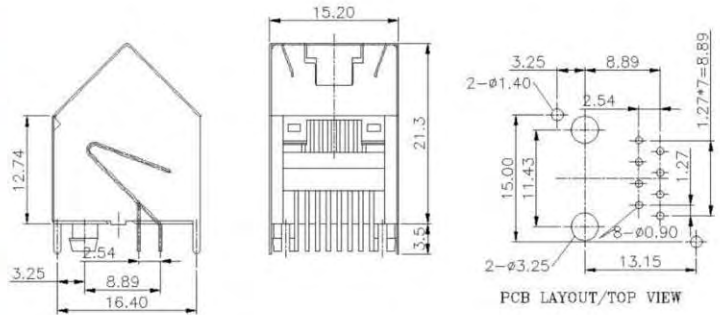
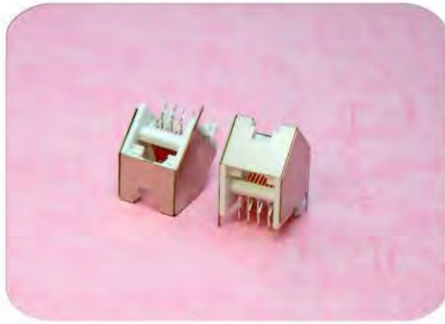
MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

J021 SERIES J045 SERIES



J045-8P8C-S-TH

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/SHIELDED) 45 DEGREE

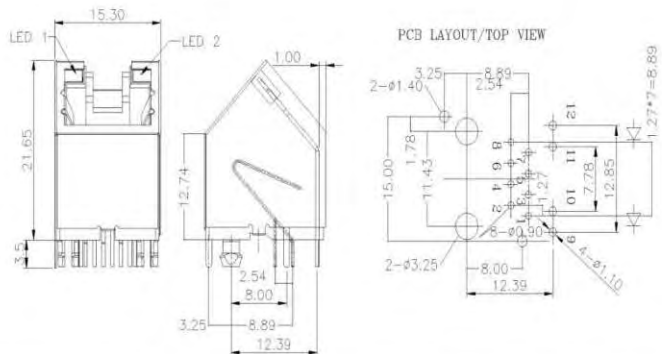
MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.



J045-8P8C-S-LED-TH

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/SHIELDED OR W/O SHIELDED)(W/LED) 45 DEGREE

MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

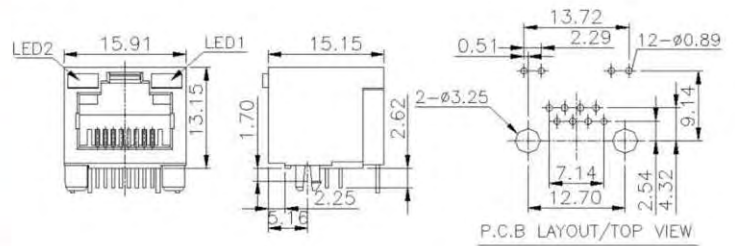
PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.

New Specification

J045 SERIES



J099-8P8C-LED-TH

SPECIFICATIONS:

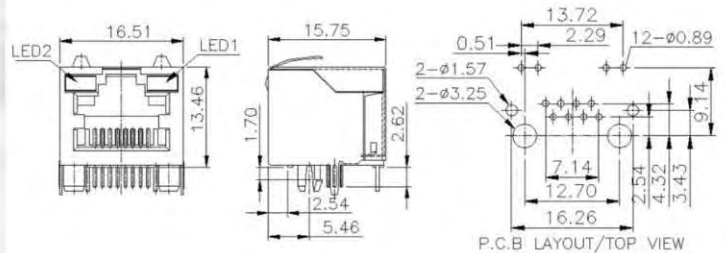
RJ45 8P8C PCB JACK TH (W/SHIELDED OR W/O SHIELDED) (LED) SIDE ENTRY

MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.



J099-8P8C-S-LED-TH

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/SHIELDED OR W/O SHIELDED) (LED) SIDE ENTRY

MATERIALS :

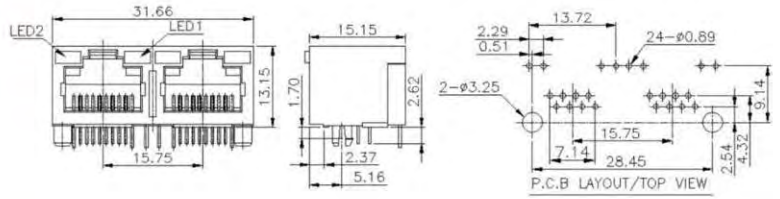
HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.

J099 SERIES



J099-8P8C-LED-TH-2PORTS

SPECIFICATIONS:

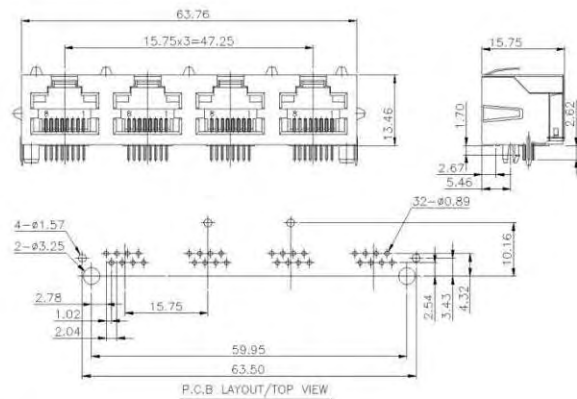
RJ45 8P8C PCB JACK TH (W/SHIELDED OR W/O SHIELDED)(LED) SIDE ENTRY

MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.



J099-8P8C-S-TH-4PORTS

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/SHIELDED)(LED) SIDE ENTRY

MATERIALS :

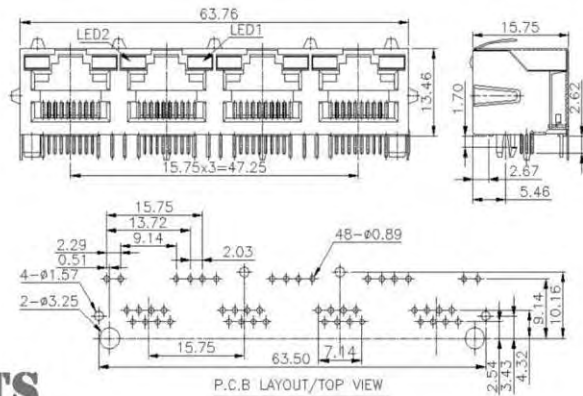
HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.

J099 SERIES



J099-8P8C-S-LED-TH-4PORTS

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/SHIELDED)(LED) SIDE ENTRY

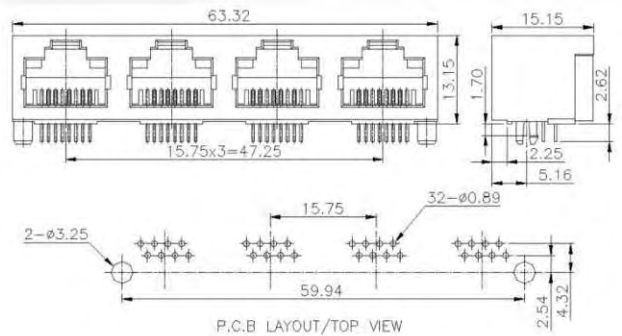
MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.



J099-8P8C-TH-4PORTS

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/O SHIELDED)(LED) SIDE ENTRY

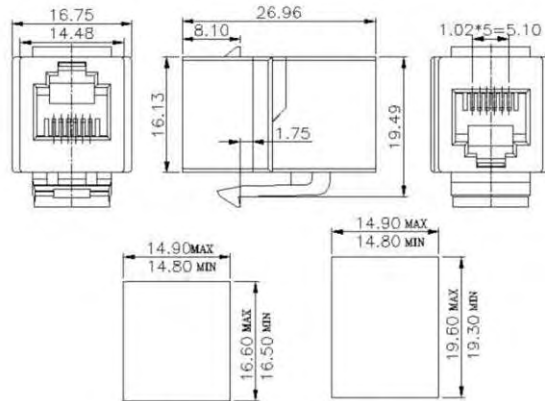
MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

J099 SERIES



Front Panel Jack Only Clearance W/O Latch Feature Single Panel-Latch Clearance Panel Thickness 1.60mm

J201-6P6C(UTP/STP)

SPECIFICATIONS:

COUPLER 6P6C CAT3 (UTP / STP)

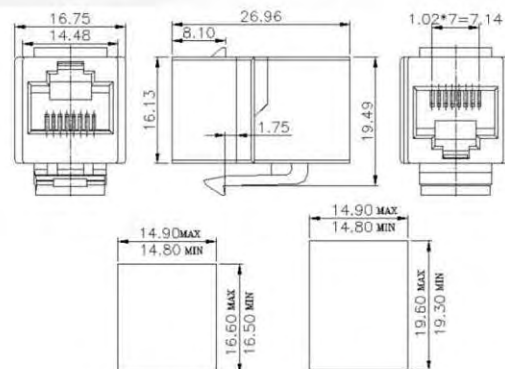
MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC. THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT. TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.



Front Panel Jack Only Clearance W/O Latch Feature Single Panel-Latch Clearance Panel Thickness 1.60mm

J201-8P8C(UTP/STP)

SPECIFICATIONS:

COUPLER 8P8C CAT3 (UTP / STP)

MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC. THERMOPLASTIC UL94V-0."

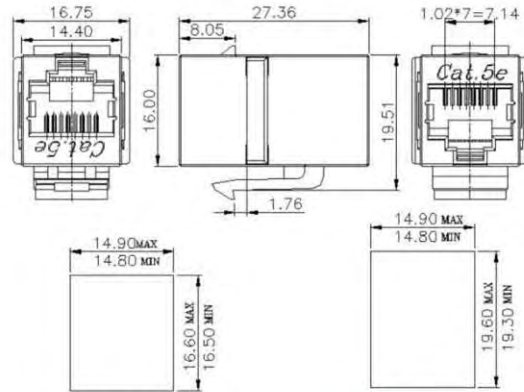
PLATING: "GOLD PLATING OVER NICKEL IN CONTACT. TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.



J201 SERIES



Front Panel Jack Only Clearance
W/O Latch Feature

Single Panel-Latch Clearance
Panel Thickness 1.90mm

J201-8P8C(UTP/STP)

SPECIFICATIONS:

COUPLER 8P8C CAT5E (UTP / STP)

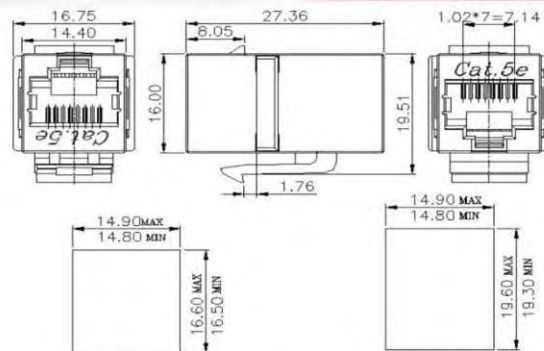
MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.



Front Panel Jack Only Clearance
W/O Latch Feature

Single Panel-Latch Clearance
Panel Thickness 1.90mm

J201-8P8C-STP

SPECIFICATIONS:

COUPLER 8P8C CAT5E

MATERIALS :

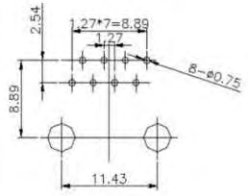
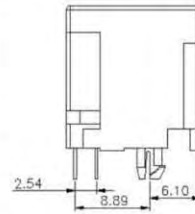
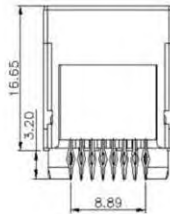
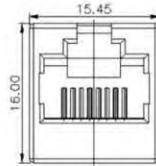
HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.

J201 SERIES



J259-8P8C-PRESS FIT

SPECIFICATIONS:

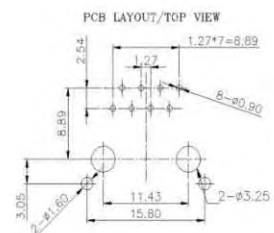
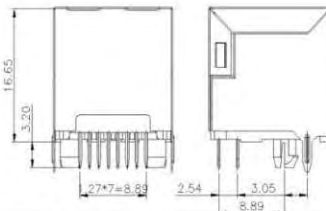
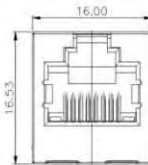
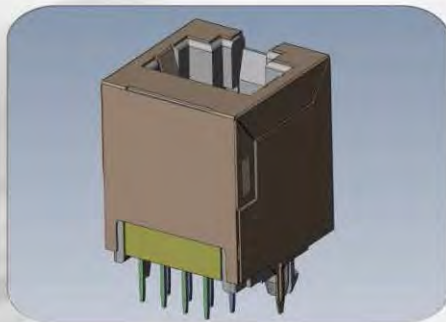
RJ45 8P8C PCB JACK TH (W/O SHIELDED) TOP ENTRY

MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.



J259-8P8C-S

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/SHIELDED) TOP ENTRY

MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.

J259 SERIES



J267-8P8C-TH

SPECIFICATIONS:

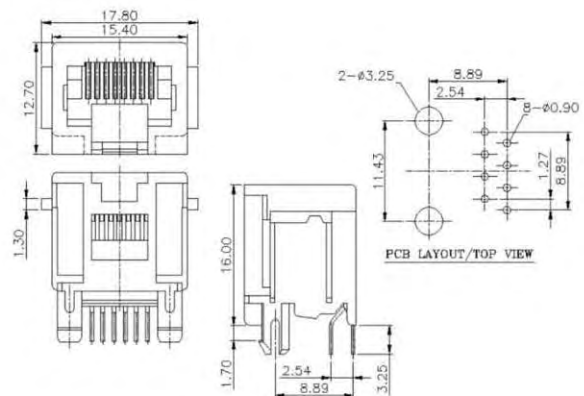
RJ45 8P8C PCB JACK TH (W/O SHIELDED) TOP ENTRY

MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.



J267-8P8C-S-TH

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/SHIELDED) TOP ENTRY

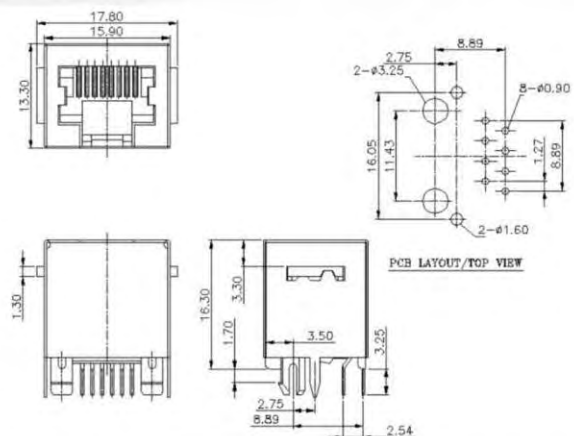
MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.



J267 SERIES



J268-6P4C-TH

SPECIFICATIONS:

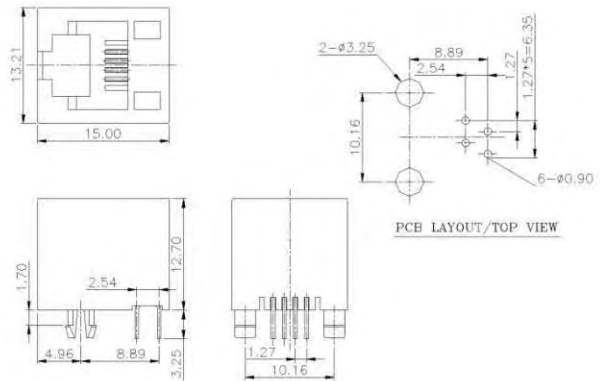
RJ45 8P8C PCB JACK TH (W/O SHIELDED) TOP ENTRY

MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.



J268-6P4C-SMT

SPECIFICATIONS:

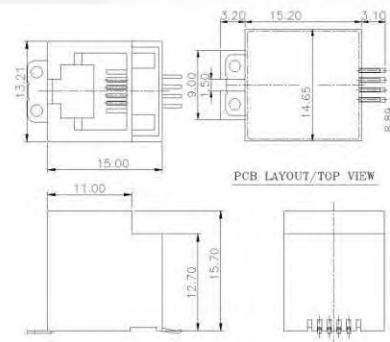
RJ45 8P8C PCB JACK SMT (W/O SHIELDED) TOP ENTRY

MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.



J268 SERIES



J268-8P8C-TH

SPECIFICATIONS:

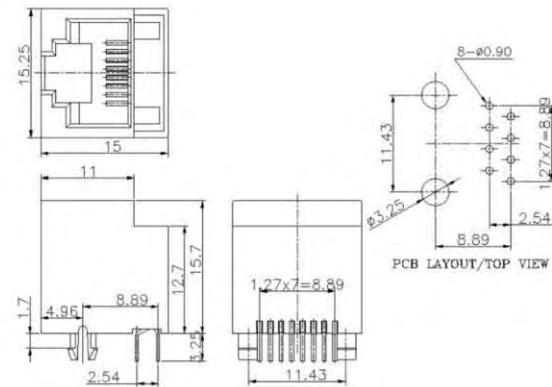
RJ45 8P8C PCB JACK TH (W/O SHIELDED) TOP ENTRY

MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.



J268-8P8C-SMT

SPECIFICATIONS:

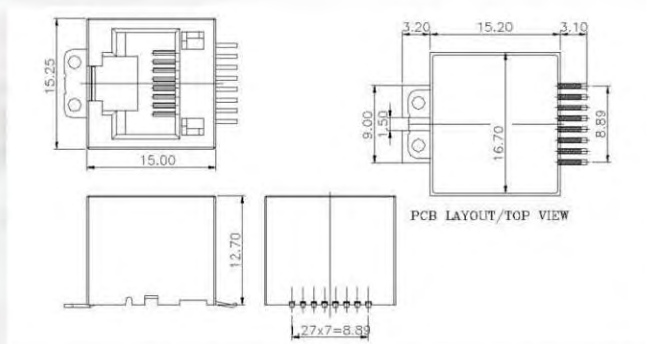
RJ45 8P8C PCB JACK SMT (W/O SHIELDED) TOP ENTRY

MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.



J268 SERIES



J268-8P8C-S-SMT

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/O SHIELDED) TOP ENTRY

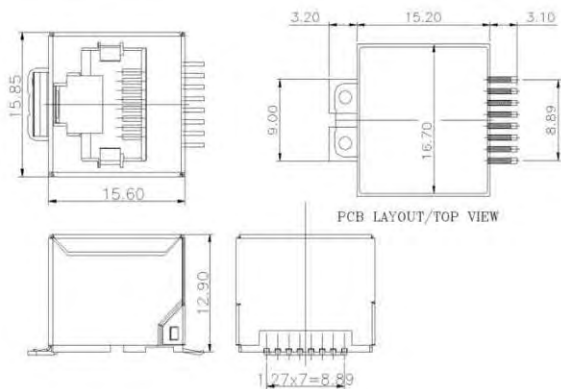
MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.



New Specification



J269-8P8C-PRESS FIT

SPECIFICATIONS:

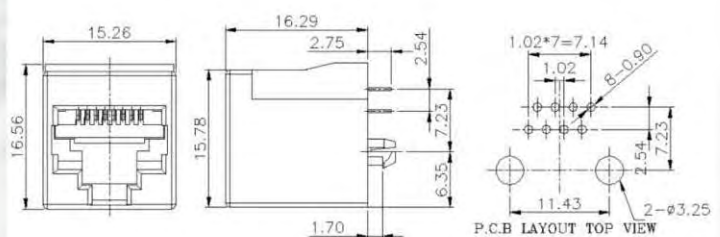
RJ45 8P8C PCB JACK SMT (W/O SHIELDED) TOP ENTRY

MATERIALS :

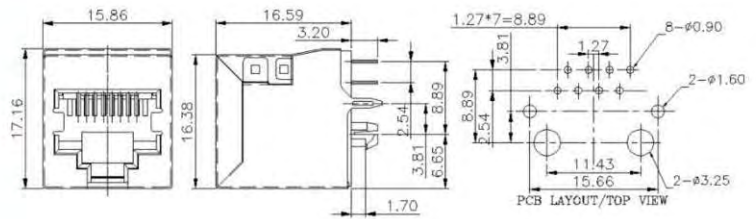
HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.



J268 SERIES J269 SERIES



J289-8P8C-S-TH

SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/O SHIELDED) TOP ENTRY

MATERIALS :

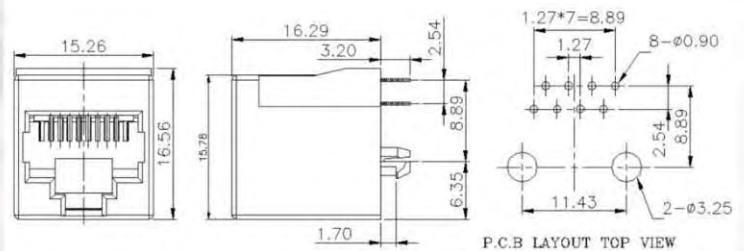
HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.

New Specification



J289-8P8C-TH

SPECIFICATIONS:

RJ45 8P8C PCB JACK SMT (W/O SHIELDED) TOP ENTRY

MATERIALS :

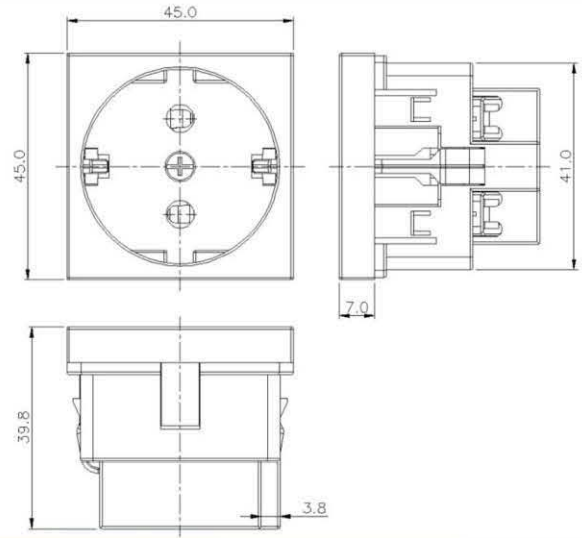
HOUSING: "ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT.
TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

J289 SERIES

J901 SERIES



MATERIALS :

PLASTIC HOUSING :

"ENGINEERING THERMOPLASTIC.
THERMOPLASTIC UL94V-0."

SPRINGS :

PHOSPHOR BRONZE.

GROUND SPRING PLATING :

TIN PLATING OVER NICKEL IN SOLDER AREA .

New Specification

POWER SOCKET

High Quality

Fast Deliverytime

Best Price



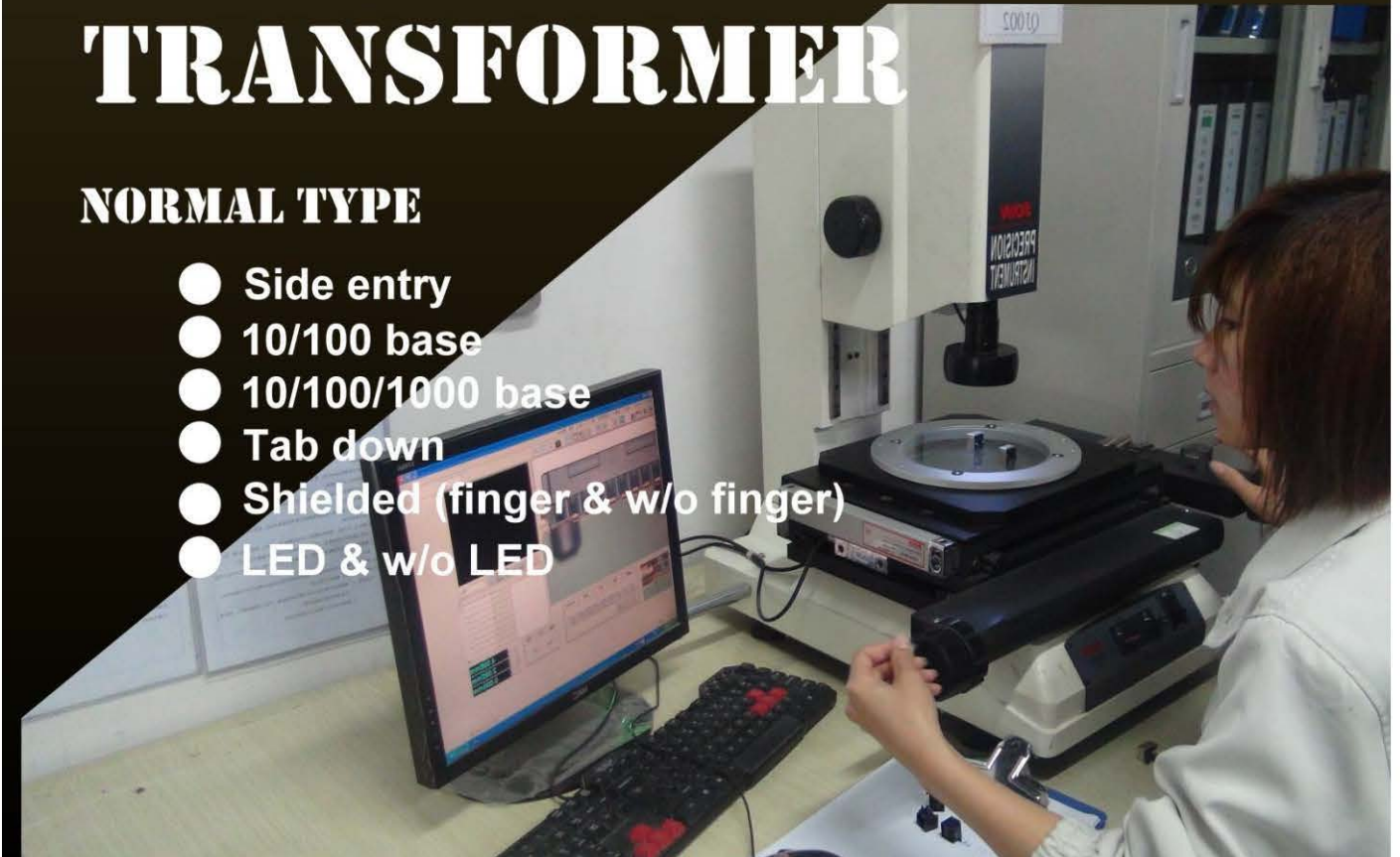
J007 series



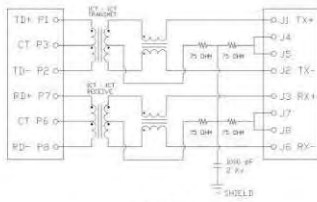
TRANSFORMER

NORMAL TYPE

- Side entry
- 10/100 base
- 10/100/1000 base
- Tab down
- Shielded (finger & w/o finger)
- LED & w/o LED

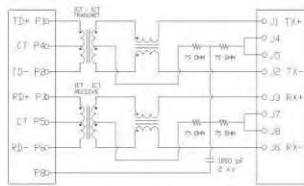


Normal Type Magnetic



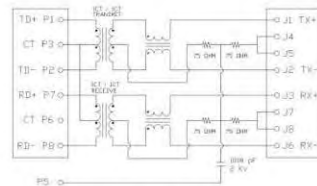
JC-01
P1-P3-P2,J1-J2
P7-P6-P8,J3-J6

10/100 base



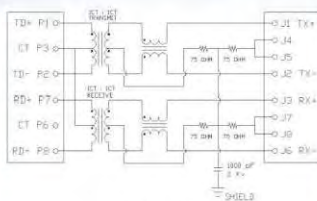
JC-02
P1-P4-P2,J1-J2
P3-P5-P6,J3-J6

10/100 base



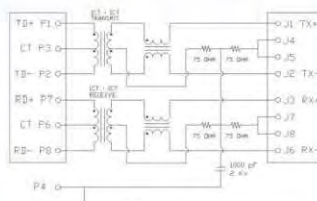
JC-03
P1-P3-P2,J1-J2
P7-P3-P8,J3-J6

10/100 base



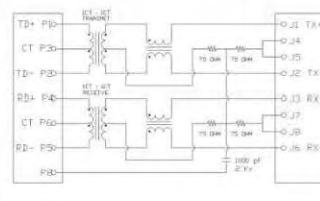
JC-04
P1-P3-P2,J1-J2
P7-P3-P8,J3-J6

10/100 base



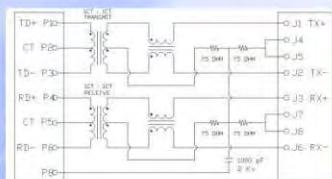
JC-07
P1-P3-P2,J1-J2
P7-P6-P8,J3-J6

10/100 base



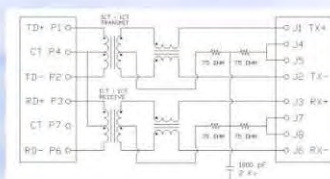
JC-09
P1-P3-P2,J1-J2
P4-P6-P5,J3-J6

10/100 base



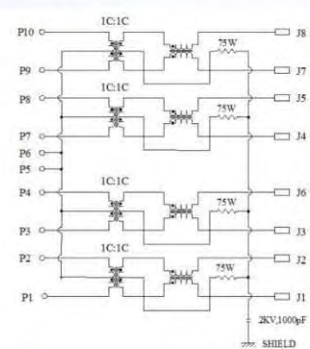
JC-10
P1-P2-P3,J1-J2
P4-P5-P6,J3-J6

10/100 base



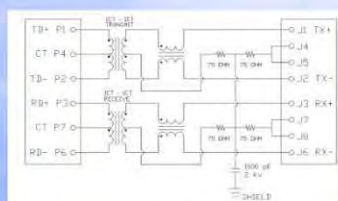
JC-11
P1-P4-P2,J1-J2
P3-P4-P6,J3-J6

10/100 base



JC-05
P1-P5,6-P2,J1-J2
P3-P5,6-P4,J3-J6
P7-P5,6-P8,J4-J5
P9-P5,6-P10,J7-J8

**10/100/1000 base
giga port**

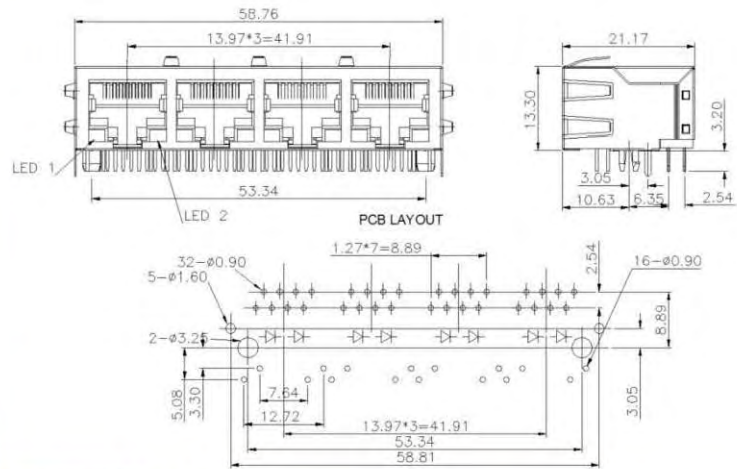
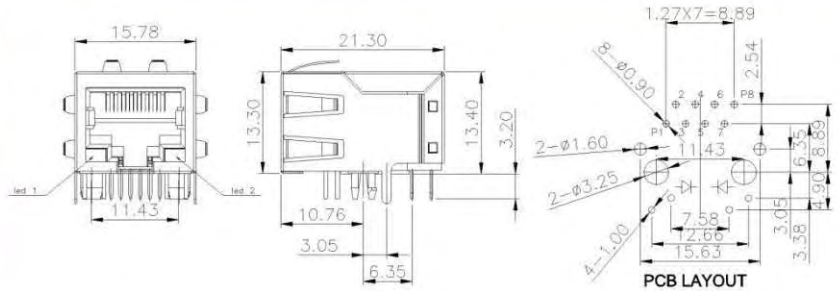


JC-13
P1-P4-P2,J1-J2
P3-P7-P6,J3-J6

10/100 base

TRANSFORMER

J007 SERIES



SPECIFICATIONS:

RJ45 8P8C PCB JACK TH (W/SHIELDED) SIDE ENTRY

MATERIALS :

HOUSING: "ENGINEERING THERMOPLASTIC. THERMOPLASTIC UL94V-0."

PLATING: "GOLD PLATING OVER NICKEL IN CONTACT. TIN PLATING OVER NICKEL IN SOLDER AREA."

CONTACT: PHOSPHOR BRONZE.

SHIELDED : BRASS WITH NICKEL PLATED.



New Specification

TRANSFORMER



We offer our customers a variety of OEM & ODM selection, stamping, Terminal strip, and injection molding. Our RJ can be applied to car, Electronic Equipment, CNC equipment, medical equipment, sporting equipment ... etc.

We also aim at fast delivery and high efficiency customer service.

INJECTION MOLDING
OEM & ODM STAMPING



We can provide :
Mold design & development
Metal stamping
Plastic injection
Mold component mold & Tooling
Auto-assembly machine & fixture development

MOLD DESIGN

I-PEX(20448-001R-0.81)+COAXIALCABLE0.81+I-PEX(20448-001R-1.81)



IPEX-Fourth Generation

I-PEX(20428-001R)+COAXIALCABLE1.13+I-PEX(20425001R)



IPEX-Second Generation

HIROSE+COAXIAL CABLE1.32+HIROSE



MURATA+COAXIAL CABLE 0.81+MURATA



BNC-PLUG+RG-174+FAKR-JACK



SMA-JACK-R/P-THREAD10+CFD-100+SMA-JACK-R/P-THREAD10



MCX-PLUG+RG316+MCX-JACK



SMA-JACK-THREAD10-For PCB+COAXIA CABLE1.32+SMA-PLUG-R/A



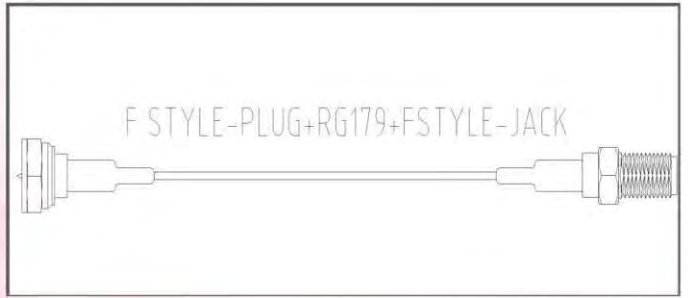
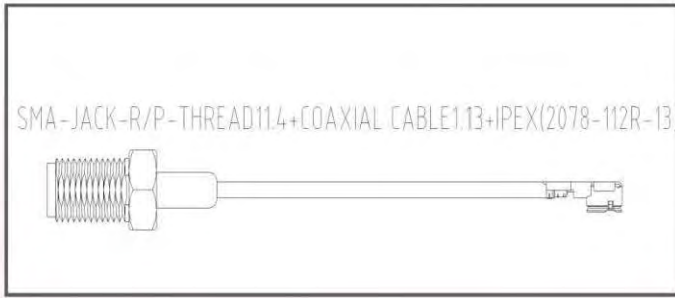
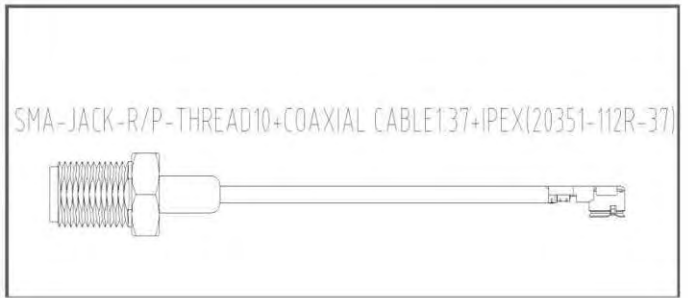
MAC-PLUG-R/A+RG-316+MCX-PLUG



MMCX-PLUG+RG-316+MMCX-JACK



COAXIAL CABLE



COAXIAL CABLE